

## **Module Description**

MCT is the leading supplier of Strip Test handling and marking equipment. Our products are designed to meet evolving market needs of testing and marking arrays of devices in either singulated or leadframe f ormat.

MCT meets the requirement for Test handling capable of handling devices in strips and laminate leadframes.

The MCT SH-5000 is capable of handling a vast array of strip and laminate lead-frame sizes. This specification defines the mechanical, electrical, software control, functional, safety, general and buy-off requirements of the equipment. The Equipment is designed to comply with S2-93 and CE directives.

## **Equipment Overview**

The MCT SH-5000 is our second generation strip test handler that provides increased performance and greater flexibility at a lower cost. The SH-5000 is a universal strip test handler for all current and anticipated semiconductor device families including CSP, QFN, BGA, SO, SOT, QFP, to name a few. The SH-5000 supports single to massively parallel site testing, providing industry leading throughput.

MCT offers various configurations and optional features to meet your ever changing production requirements. The SH-5000 is supported by our industry leading data management and analysis software products such as Smart-Track® and Smart-EM, which allow you to optimize your production and quality control processes. The SH-5000 utilizes an innovative thermal conduction technology to rapidly condition strips to your desired thermal setpoint.

## **Equipment Advantages**

Increased tester utilization, first pass yields and throughput.

Decreasd cost of test, jam rates, kit change over times.

Quality applications & design engineers, data management & analysis and after sale support & spares.



SH-5000 Functional / Performance	Requirements		
General			
Strip-to-Strip Index Time	<3.2 secs at zero test time		
Intra-Strip Index Time:	<350 msec for < 24mm move <300 msec for	< 15mm move	
Positioning Accuracy:	± 25 microns with Vision		
Contacting Controls:	Z-Height Position or Z-Force Limiting		
Conversion Kit Changeover:	< 30 minutes		
Multi-site Test:	Single Site to Massively Parallel		
Temperature Range:	-55 C* to +160 C (*with optional chiller)		
Temperature Accuracy:	+/- 2 C		
Soak Limitation:	Not soak limited for most applications		
Re-Ambient	< 60 C from HOT Testing and > 10C from COLD	Testing	
Defrosting	One Defrost Cycle per Day		
Time to Temperature*:	From ambient to any temperature set point < 45 minutes (*with optional chiller)		
Temperature Slew Time*:	From any temperature set point to ambient < 45 minutes (*with optional chiller)		
2D Read:	Topside, Bottom side - SEMI T9-0200		
Jam Rate	< 1 jam in 1000 strips run		
Uptime	> 97%		
MTTA Mean Time to Assist	< 2 min.		
MTBF Mean Time Between Failure (any failure that is not considered an assist)	> 200 hours		
MTTR Mean Time to Repair	< 20 min.		
Z-force/contacting force	77 Kgf or optional 120 and 194 KgF versions available (increased strip to strip index time)		
ESD		able as an option - Ground Fault Monitoring: Available as an option	
Tracked I/O	√ 50 v — within 75 min of device path - ionizer: Availa	as an option - Ground Fault Monitoring: Available as an option	
	20 110 mm		
Magazine Length	28-110 mm 115-280 mm	Each equipment purchase entitles the	
Magazine Length		purchaser three (3) training credits, which is inclusive of training for up to five (5) personnel for maximum of three (3) days. Training shall	
Magazine Height	200-450 mm		
Number of Cassettes	1 input, 1 output	be conducted at customer's site to operators,	
Exchange on the fly	Yes	service technicians and Equipment Engineers.	
Slotted I/O	00.440	Training shall be conducted in English.	
Cassette Width	28-110 mm	Basic (2 days) shall include operation and basic trouble shooting of mechanical,	
Cassette Length	115-280 mm	electrical, software and hardware.	
Cassette Height	70-160 mm	Basic operation – Starting system, software/	
Cassette Pitch	4.5 mm minimum	menus, operating etc.	
Number of Cassettes	355 mm available for cassettes	Device kit conversion	
Exchange on the fly	Yes	Intermediate (2-3 days – suggested that it	
Docking		occur 1 to 2 months after basic training). In	
Docking Plane	Horizontal	depth machine training as follow:	
Infinite plane	Yes	Mechanical alignment procedures and diagnostic techniques	
Configuration		Electrical/electronics maintenance.	
Product Flow	Left to right	troubleshooting and tuning procedures	
Size:	1.7 x 1.5 x 1.0 m (L x W x H)	Daily/Weekly/Monthly/Bimonthly/Quarterly/	
Weight	1500 kgs	half yearly/yearly machine preventative	
Mobility	Transportable	Maintenance.	
Clearance for manipulator foot	100 mm		
Embedded Controller - High Performance Industrial PC			
CPU	Core2 Duo 2GHZ or greater		
Main Memory	DDR, 1 GB or greater		
Hard Disk	80 GB or greater		
Removable Storage	DVD / CD R/W Drive, 3.5" 1.44 MB Diskette		
Video Adaptor	VGA – ONBOARD		
Power Supply	350W or greater		
USB Ports – 2/1.1	(4) present, (1) port available on back of handler		
Printer Port	Present but committed - not available to user		
Ethernet Ports	(2) available on back of handler		
Operating System	MS Windows XP		
Operating Conditions			
Ambient Temperature	25 C		
AUDIOUR ICHIDEIGIUE			
	Dust Class 100K or Retter		
Clean Room	Dust Class 100K or Better		
Clean Room Relative Humidity	20-80% Non-Condensing		
Clean Room Relative Humidity Maximum Floor Load:	20-80% Non-Condensing 750 kg/m2		
Clean Room Relative Humidity	20-80% Non-Condensing 750 kg/m2 < 65 db at 1m	als excluding consumables or a maximum of 13 months	

